

RoHS/REACH Compliance and Halogen Free Statement

Power Integrations currently manufactures both non-RoHS and RoHS compliant products as shown in the table below. Qspeed and HiperPFS-2 products are currently assembled with a soft solder die attach material containing lead but exempted by Exemption 7(a)*. All new products are lead-free and halogen-free where technologically possible.

Product	Package or Designator	RoHS Compliant	REACH Compliant	Halogen Free
All	xy, SO-8, SOT-3, TO-200-2S, TO-220-3Q, TO-220-3R	Yes	Yes	Yes
All	xN	Yes	Yes	Yes ¹
All	FN	Yes	Yes	No ²
DPA	RN	Yes	Yes	No ²
DPA, TOP-GX	R	No ³	Yes	No ²

x = a 1 or 2-alphanumeric character package designator y = G or Blank or a number

1 = Some products may contain Halogen 2 = Halogen in Mold Compound

3 = Lead in Plating

* Exemption 7(a) Lead in high melting temperature type solders (i.e. lead-based alloys containing 85 % by weight or more lead)

Any product identified as “RoHS Compliant” is determined by our component contract manufacturers and supported by independent laboratory testing. Power Integrations does not knowingly add the restricted substances to the “RoHS Compliant” products and certifies that such products are compliant to RoHS Directive 2011/65/EU of the European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronics equipment. However, being a component supplier, the additional requirements of RoHS Recast do not apply.

Halogen-free products are in accordance to IEC 61249-2-21.

This document certifies that the information provided by Power Integrations is accurate to the best of our knowledge but the information is not intended to substitute for any testing that may be required to determine the suitability of the products for any particular application.

Sincerely,



Raja Petrakian
 VP of Operations
 March 03, 2016